

06-18-2001

Docket No. : 501.40192X00

FORM PTO-1595
1-31-92

RE



HEET

U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

101750908

To the Honorable Commissioner of Patents and Trademarks. Please receive the attached original documents or copy thereof.

1. Name of conveying party(ies):
Yuichi YOSHINO

06/08/01

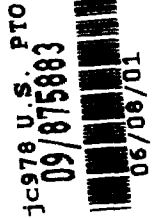
Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies):

- 1) Hitachi, Ltd.
- 2) Hitachi Device Engineering Co., Ltd.

Street Address:

- 1) 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan
- 2) 3681, Hayano, Mobara-shi, Chiba-ken 297-8581, Japan



3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other _____

Execution Date: May 21, 2001

Additional name(s) & address(es) attached? Yes No

4. Application number(s) or patent number(s):

09/875883

If this document is being filed together with a new application, the execution date of the application is: May 21, 2002

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: ANTONELLI, TERRY, STOUT & KRAUS, LLP

Internal Address:

Street Address: 1300 North Seventeenth Street
Suite 1800

City: Arlington State: VA Zip: 22209

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$40.00

- Enclosed
- Any deficiencies may be charged to deposit account
- Authorized to be charged to deposit account

8. Deposit account number: 01-2135

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Melvin Kraus
Name of Person Signing

Signature

June 8, 2001
Date

Attorney Registration No. 22,466

Total number of pages including cover sheet, attachments, and document: 2

OMB No. 0651-0011 (exp. 4/94)

ASSIGNMENT

(讓 渡 証)

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to the below named inventor(s), citizens of Japan by HITACHI, LTD., and HITACHI DEVICE ENGINEERING CO., LTD., corporations organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, and 3681, Hayano, Mobara-shi, Chiba-ken 297-8581, Japan, respectively, receipt of which is hereby acknowledged, we, the below named inventor(s), do hereby sell and assign to said HITACHI, LTD., and HITACHI DEVICE ENGINEERING CO., LTD., their successors and assigns, all our right, title and interest, in and for the United States of America, in and to

LIQUID CRYSTAL DISPLAY DEVICE AND MOBILE PHONE

invented by us and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., and HITACHI DEVICE ENGINEERING CO., LTD., their successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made;

And we hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And we do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD., and HITACHI DEVICE ENGINEERING CO., LTD.

Signed on the date(s) indicated aside signatures:

INVENTOR(S)

(発明者フルネームサイン)

Date Signed

(署名日)

1)	<u>Yuichi Yoshino</u>	<u>May. 21, 2001</u>
2)	_____	_____
3)	_____	_____
4)	_____	_____
5)	_____	_____
6)	_____	_____
7)	_____	_____
8)	_____	_____
9)	_____	_____
10)	_____	_____